

12-14-2000



COVER SHEET

U.S. DEPARTMENT OF COMMERCE
Patent and Trademark Office

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Tab settings

101552031

To the Honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Takashi MIIDA

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies)

Name: INNOTECH CORPORATION

Internal Address:

Street Address: 3-17-6 Shinyokohama

Kouboku-ku

City: Yokohama-shi State: JAPAN ZIP:

Additional name(s) & address(es) attached? Yes No

3. Nature of conveyance:

Assignment

Merger

Security Agreement

Change of Name

Other

Execution Date: 9 November 2000

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: 9 November 2000

A. Patent Application No.(s)

B. Patent No.(s)

09715065

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: George A. Loud

Internal Address:

Street Address: LORUSSO & LOUD

3137 Mt. Vernon Avenue

City: Alexandria State: VA ZIP: 22305

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41).....\$ 40.00

Enclosed

Authorized to be charged to deposit account

8. Deposit account number:

(Attach duplicate copy of this page if paying by deposit account)

12/13/2000 NTJHAI1 00000186 09715065

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

George A. Loud
Name of Person Signing

Signature

20 November 2000
Date

Total number of pages including cover sheet, attachments, and document: 4

Mail documents to be recorded with required cover sheet information to:
Commissioner of Patents & Trademarks, Box Assignments

PATENT
REEL: 011322 FRAME: 0178

ASSIGNMENT

WHEREAS, WE, Takashi MIIDA
of, respectively, c/o INNOTECH CORPORATION, 3-17-6 Shinyokohama
Kouhoku-ku, Yokohama-shi, 222-8580, Japan

have invented certain improvements in "SOLID STATE IMAGING DEVICE, METHOD
OF MANUFACTURING THE SAME, AND SOLID STATE IMAGING SYSTEM" set forth in
an application for Letters Patent of the United States; and

WHEREAS, INNOTECH CORPORATION
of 3-17-6 Shinyokohama Kouhoku-ku, Yokohama-shi, 222-8580, Japan
is desirous of acquiring an interest therein;

NOW THEREFORE, for and in consideration of the sum of
One Dollar (\$1.00) and other good and valuable consideration, the
receipt of which is hereby acknowledged, we, Takashi MIIDA

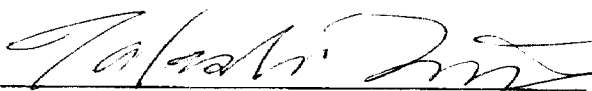
by these presents do sell, assign and transfer unto said _____
INNOTECH CORPORATION its

successors, legal representatives, heirs and assigns, the full
and exclusive right, title and interest in the United States of
America said application executed on the 9th day of
November, 2000, (and we hereby authorize my attorneys,
authorized to prosecute said application, to here insert the
filing date and serial number of said application, when known:
Serial No. _____ Filed _____) to all Letters

Patents in the United States which may be granted on said application, to all divisions, continuations and continuations-in-part of said application, or reissues or extensions of said Letters Patent, all applications for Letters Patent and all Letters Patent therefor, to be held and enjoyed by _____

INNOTECH CORPORATION for its use and behoof and for its legal representatives, successors, heirs, and assigns, to the full end of the term for which said Letters Patent are granted and any extensions thereof, as fully and entirely as the same would have been held by us had this assignment and sale not been made; and for the same consideration, we hereby covenant and agree that, at the time of execution and delivery of this instrument, we hold good and full right and lawful authority to sell and convey the application for Letters Patent above mentioned in the manner herein set forth; and for the same consideration we hereby covenant and agree that we will, whenever counsel of INNOTECH CORPORATION or the counsel of its successors, legal representatives, heirs or assigns, shall advise that any proceeding in connection with said application for Letters Patent, or any proceeding in connection with Letters Patent in the United States, including interference proceedings, is lawful and desirable, or that any division, continuation or continuation-in-part of any application for Letters Patent, or any reissue or extension of any Letters Patent to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary

or required to be done for the procurement, maintenance,
enforcement and defense of said Letters Patent, without charge to
us, our successors, legal representatives, heirs and assigns, but
at the cost and expense of INNOTECH CORPORATION its
successors, legal representatives, heirs and assigns; and we
hereby request the Commissioner of Patents to issue said Letters
Patent to INNOTECH CORPORATION as assignee thereof.



Takashi MIIDA date

Nov. 9,
2000

date

date